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## **DAISHO MICROLINE HOLDINGS LIMITED**

*(Incorporated in Bermuda with limited liability)*

**(Stock Code: 0567)**

### **CHANGE IN HEAD OFFICE AND PRINCIPAL PLACE OF BUSINESS IN HONG KONG**

The Board of directors (the “**Board**”) of Daisho Microline Holdings Limited (the “**Company**”) hereby announces that the Company’s head office and principal place of business in Hong Kong will be relocated to Unit A, 10/F, Fook Hing Industrial Building, 33 Lee Chung Street, Chai Wan, Hong Kong with effect from 10 July 2020.

By order of the Board  
**Daisho Microline Holdings Limited**  
**Cheung Lai Ming**  
*Chairman*

Hong Kong, 10 July 2020

*As at the date of this announcement, the Board consists of three executive directors, namely, CHEUNG Lai Ming and LEE Man Kwong and three independent non-executive directors, namely, LEUNG King Fai, CHOU Yuk Yan and CHAN Yau Ching, Bob.*